

# AON2406

# 20V N-Channel MOSFET

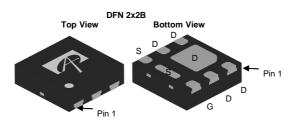
# **General Description**

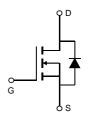
The AON2406 combines advanced trench MOSFET technology with a low resistance package to provide extremely low  $R_{\text{DS(ON)}}$ . This device is ideal for load switch and battery protection applications.

# **Product Summary**

 $\begin{array}{lll} V_{DS} & 20V \\ I_D & (at \, V_{GS} \!\!=\!\! 4.5V) & 8A \\ R_{DS(ON)} & (at \, V_{GS} \!\!=\!\! 4.5V) & < 12.5 m \Omega \\ R_{DS(ON)} & (at \, V_{GS} \!\!=\!\! 2.5V) & < 15 m \Omega \\ R_{DS(ON)} & (at \, V_{GS} \!\!=\!\! 1.8V) & < 19 m \Omega \\ R_{DS(ON)} & (at \, V_{GS} \!\!=\!\! 1.5V) & < 24 m \Omega \end{array}$ 







Absolute Maximum Ratings T <sub>A</sub> =25℃ unless otherwise noted							
Parameter		Symbol	Maximum	Units			
Drain-Source Voltage		$V_{DS}$	20	V			
Gate-Source Voltage		$V_{GS}$	±8	V			
Continuous Drain	T <sub>A</sub> =25℃	I-	8	۸			
Current <sup>G</sup>	T <sub>A</sub> =70℃	'D	6	A			
Pulsed Drain Current <sup>C</sup>		I <sub>DM</sub>	32				
	T <sub>A</sub> =25℃	P <sub>D</sub>	2.8	W			
Power Dissipation <sup>A</sup>	T <sub>A</sub> =70℃	' D	1.8	\ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \			
Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>STG</sub>	-55 to 150	C			

Thermal Characteristics								
Parameter		Symbol	Тур	Max	Units			
Maximum Junction-to-Ambient A			37	45	€/W			
Maximum Junction-to-Ambient AD			66	80	℃/W			



#### Electrical Characteristics (T<sub>J</sub>=25℃ unless otherwise noted)

Symbol	Parameter	Conditions	Min	Тур	Max	Units
STATIC I	PARAMETERS					
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	$I_D = 250 \mu A, V_{GS} = 0 V$	20			V
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	V <sub>DS</sub> =20V, V <sub>GS</sub> =0V			1	μΑ
1	Gate-Body leakage current	$V_{DS}=0V, V_{GS}=\pm 8V$			5 ±100	nA
I <sub>GSS</sub>	Gate Threshold Voltage	$V_{DS} = V_{GS}, V_{GS} = \pm 0.0$ $V_{DS} = V_{GS}, I_{D} = 250 \mu A$	0.4	0.67	1.0	V
V <sub>GS(th)</sub>				0.67	1.0	A
I <sub>D(ON)</sub>	On state drain current	V <sub>GS</sub> =4.5V, V <sub>DS</sub> =5V	32	40	40.5	А
		$V_{GS}$ =4.5V, $I_D$ =8A $T_J$ =125 $^{\circ}$ C		10 13.5	12.5 17	mΩ
R <sub>DS(ON)</sub> Stat	Static Drain-Source On-Resistance	$V_{GS}=2.5V, I_{D}=6A$		11.5	17	mΩ
	Static Brain Gource On Resistance	$V_{GS}=1.8V, I_{D}=4A$		14	19	mΩ
		$V_{GS}=1.5V, I_{D}=1.4$		17	24	mΩ
g <sub>FS</sub>	Forward Transconductance	$V_{DS}=5V$ , $I_D=8A$		50		S
V <sub>SD</sub>	Diode Forward Voltage	I <sub>S</sub> =1A,V <sub>GS</sub> =0V		0.6	1	V
Is	Maximum Body-Diode Continuous Cur			4.5	Α	
DYNAMI	C PARAMETERS				<u>I</u>	
C <sub>iss</sub>	Input Capacitance			1140		pF
C <sub>oss</sub>	Output Capacitance	V <sub>GS</sub> =0V, V <sub>DS</sub> =10V, f=1MHz		165		pF
$C_{rss}$	Reverse Transfer Capacitance	7		110		pF
$R_g$	Gate resistance	V <sub>GS</sub> =0V, V <sub>DS</sub> =0V, f=1MHz		2.2		Ω
SWITCH	ING PARAMETERS					
$Q_g$	Total Gate Charge			12.5	18	nC
$Q_{gs}$	Gate Source Charge	$V_{GS}$ =4.5V, $V_{DS}$ =10V, $I_{D}$ =8A		1.2		nC
$Q_{gd}$	Gate Drain Charge			2.7		nC
t <sub>D(on)</sub>	Turn-On DelayTime			2.7		ns
t <sub>r</sub>	Turn-On Rise Time	$V_{GS}$ =4.5V, $V_{DS}$ =10V, $R_L$ =1.25 $\Omega$ ,		3		ns
t <sub>D(off)</sub>	Turn-Off DelayTime	$R_{GEN}=3\Omega$		37		ns
t <sub>f</sub>	Turn-Off Fall Time			7		ns
t <sub>rr</sub>	Body Diode Reverse Recovery Time	I <sub>F</sub> =8A, dI/dt=100A/μs		11		ns
$Q_{rr}$	Body Diode Reverse Recovery Charge I <sub>F</sub> =8A, dl/dt=100A/μs			3		nC

A. The value of  $R_{\theta JA}$  is measured with the device mounted on  $1 \text{in}^2$  FR-4 board with 2oz. Copper, in a still air environment with  $T_{\text{A}}$  =25° C. The Power dissipation  $P_{DSM}$  is based on  $R_{\theta JA}$   $t \le 10s$  value and the maximum allowed junction temperature of  $150^{\circ}$  C. The value in any given application depends on the user's specific board design.

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B. The power dissipation  $P_D$  is based on  $T_{J(MAX)}=150\,^\circ$  C, using junction-to-case thermal resistance, and is more useful in setting the upper dissipation limit for cases where additional heatsinking is used.

C. Repetitive rating, pulse width limited by junction temperature T<sub>J(MAX)</sub>=150° C. Ratings are based on low frequency and duty cycles to keep initial  $T_J$  =25 $^{\circ}$  C.

D. The  $R_{\theta JA}$  is the sum of the thermal impedance from junction to case  $R_{\theta JC}$  and case to ambient.

E. The static characteristics in Figures 1 to 6 are obtained using <300µs pulses, duty cycle 0.5% max.

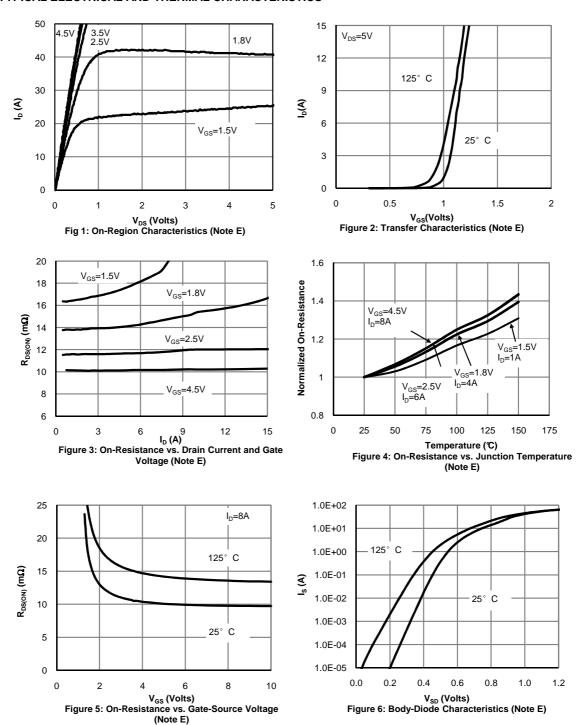
F. These curves are based on the junction-to-case thermal impedance which is measured with the device mounted to a large heatsink, assuming a maximum junction temperature of T<sub>J(MAX)</sub>=150° C. The SOA curve provides a single pulse rating.

G. The maximum current rating is package limited.

H. These tests are performed with the device mounted on 1 in FR-4 board with 2oz. Copper, in a still air environment with  $T_A=25^{\circ}$  C.



#### TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS





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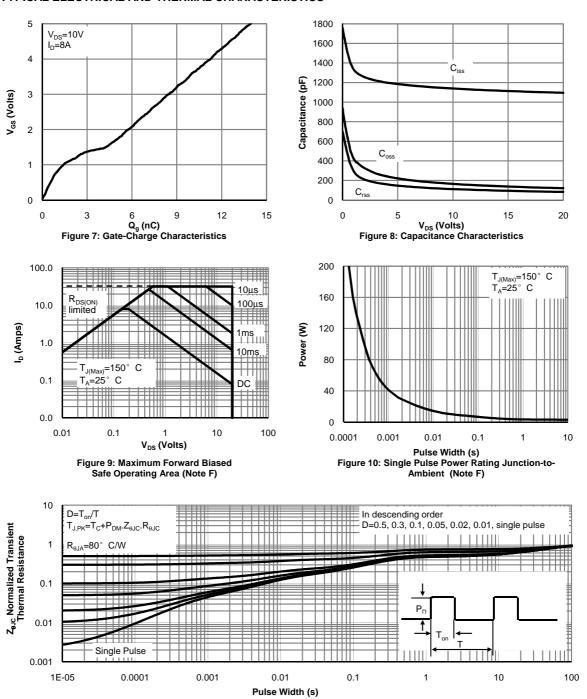
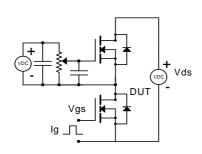
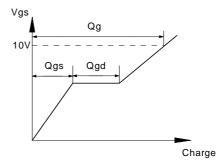


Figure 11: Normalized Maximum Transient Thermal Impedance (Note F)

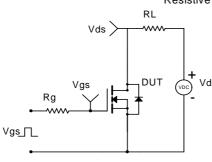


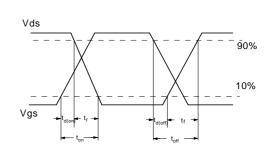
# Gate Charge Test Circuit & Waveform



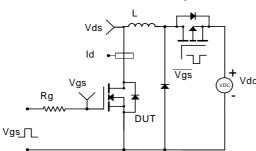


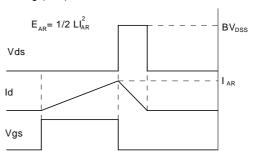
Resistive Switching Test Circuit & Waveforms



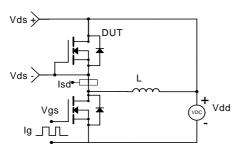


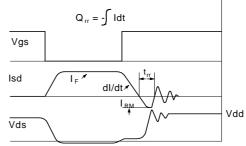
# Unclamped Inductive Switching (UIS) Test Circuit & Waveforms





# Diode Recovery Test Circuit & Waveforms





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